



芯科半导体

ELECTRONIC
PRODUCT
浙江芯科半导体有限公司

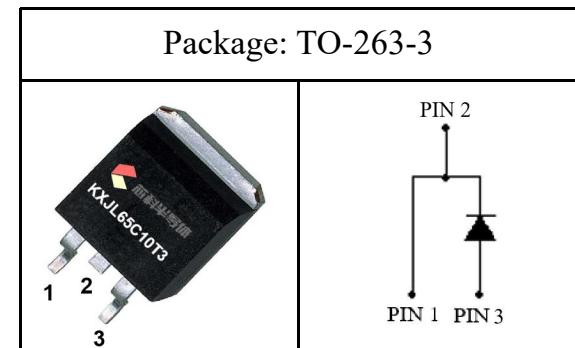
Features

- ✓ Zero forward recovery voltage
- ✓ Zero reverse recovery current
- ✓ Excellent surge current capability
- ✓ Temperature independent switching
- ✓ Positive temperature coefficient on V_F
- ✓ High frequency operation

Part NO.	KXJL65C10T3
V_{RRM}	= 650 V
$I_F(T_C=140^\circ C)$	= 10 A
Q_C	= 52 nC

Applications

- ✓ Motor drives
- ✓ Uninterruptible power supplies
- ✓ Photovoltaic inverter
- ✓ Switch mode power supplies (SMPS)



Key performance parameters

Symbol	Parameter	Test conditions	Value	Unit	Note
V_{RRM}	Repetitive peak reverse voltage	$T_C = 25^\circ C$	650	V	
V_{RSM}	Surge peak reverse voltage (DC)	$T_C = 25^\circ C$	650	V	
I_F	Continuous forward current	$T_C = 25^\circ C, D=1$ $T_C = 140^\circ C, D=1$ $T_C = 150^\circ C, D=1$	27 10 8	A	Fig.6
I_{FRM}	Repetitive forward surge current	$t_p = 10 \text{ ms}, \text{Half sine wave}$ $T_C = 25^\circ C$ $T_C = 150^\circ C$	72 60	A	
I_{FSM}	Non-repetitive forward surge current	$t_p = 10 \text{ ms}, \text{Half sine wave}$ $T_C = 25^\circ C$ $T_C = 150^\circ C$	86 62	A	
$\int i^2 dt$	$i^2 t$ value	$T_C = 25^\circ C, t_p = 10 \text{ ms}$	25	$A^2 s$	
P_{tot}	Total power dissipation	$T_C = 25^\circ C$	81	W	Fig.7
T_j	Operating junction temperature		-55 ~ 175	$^\circ C$	
T_{stg}	Storage temperature		-55 ~ 175	$^\circ C$	
t_{rr}	Reverse recovery time	$V_R=400 \text{ V}, I_F=10 \text{ A}, di/dt=200 \text{ A}/\mu s$	14.6	ns	



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SiC Schottky Diode

KXJL65C10T3

Static electrical characteristics

Symbol	Parameter	Test conditions	Value			Unit	Note
			Min.	Typ.	Max.		
V_{DC}	DC blocking voltage	$I_R = 50 \mu A, T_j = 25^\circ C$	700	-	-	V	
V_F	Diode forward voltage	$I_F = 10 A, T_j = 25^\circ C$	-	1.42	-	V	Fig.1
		$I_F = 10 A, T_j = 150^\circ C$	-	1.75	-		
I_R	Reverse current	$V_R = 650 V, T_j = 25^\circ C$	-	0.2	100	μA	Fig.2
		$V_R = 650 V, T_j = 150^\circ C$	-	10	400		
C	Total capacitance	$V_R = 0.1 V, T_j = 25^\circ C, f = 1 MHz$	-	953	-	pF	Fig.5
		$V_R = 200 V, T_j = 25^\circ C, f = 1 MHz$	-	97	-		
		$V_R = 400 V, T_j = 25^\circ C, f = 1 MHz$	-	70	-		
Q_C	Total capacitive charge	$V_R = 400 V, T_j = 25^\circ C$	-	52	-	nC	Fig.3
E_C	Capacitance stored energy	$V_R = 400 V, T_j = 25^\circ C$	-	13	-	μJ	Fig.4

Thermal characteristics

Symbol	Parameter	Value		Unit	Note
		Typ	Max		
$R_{\theta JC}$	Thermal resistance from junction to case	1.2	1.9	°C/W	Fig.8



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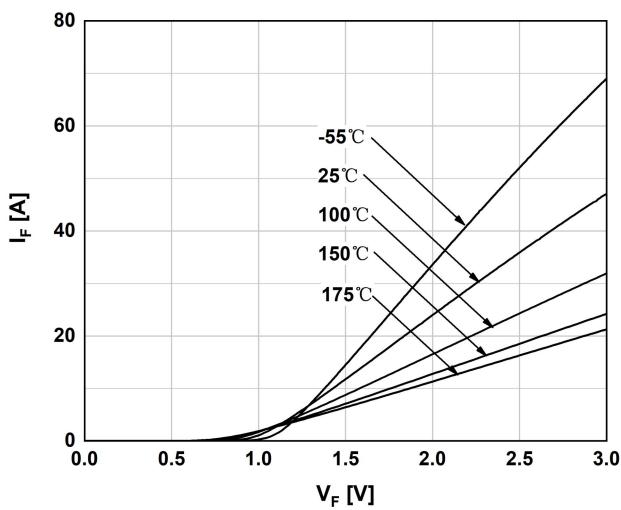


Figure.1 Typical forward characteristics

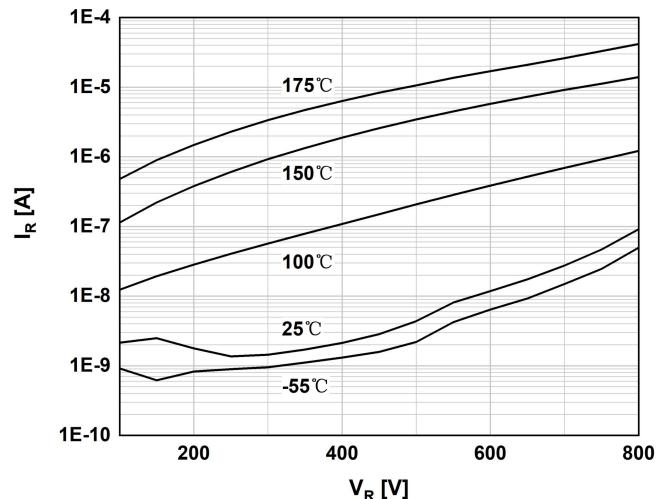


Figure.2 Reverse current vs. reverse voltage

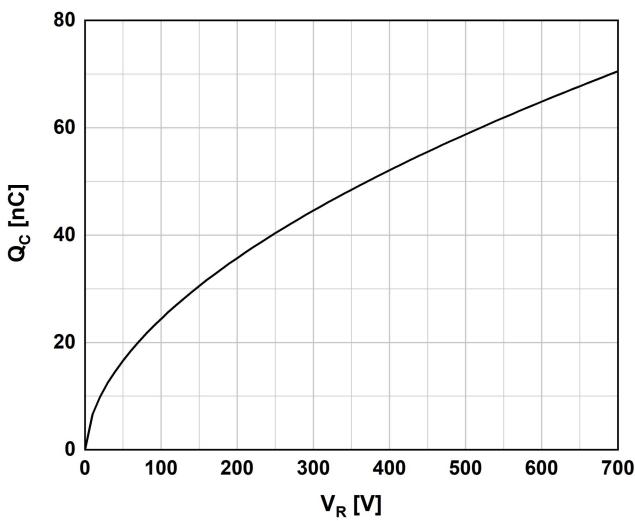


Figure.3 Capacitance charge vs reverse voltage

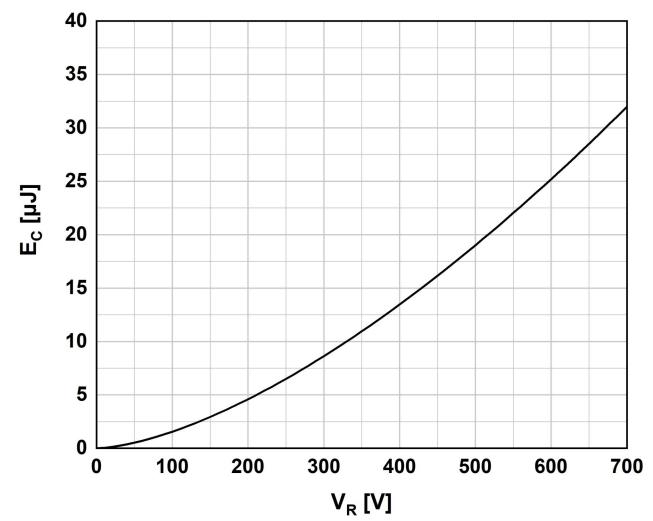


Figure.4 Capacitance stored energy



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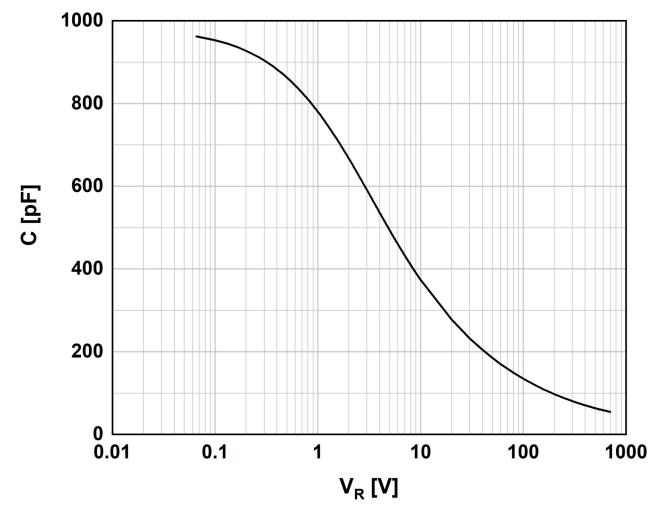


Figure.5 Capacitance vs. reverse voltage

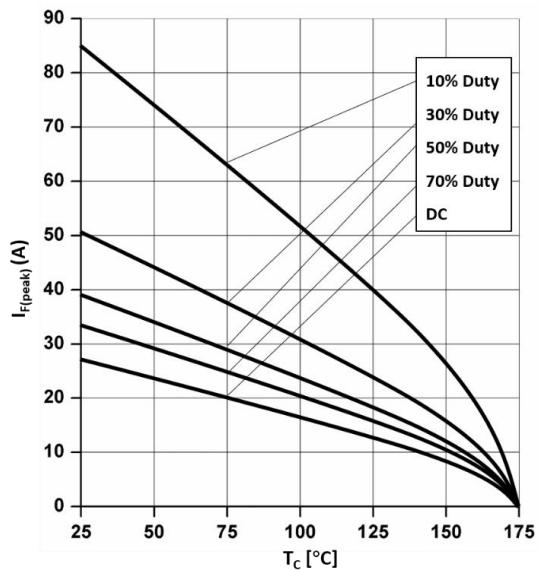


Figure.6 Diode forward current

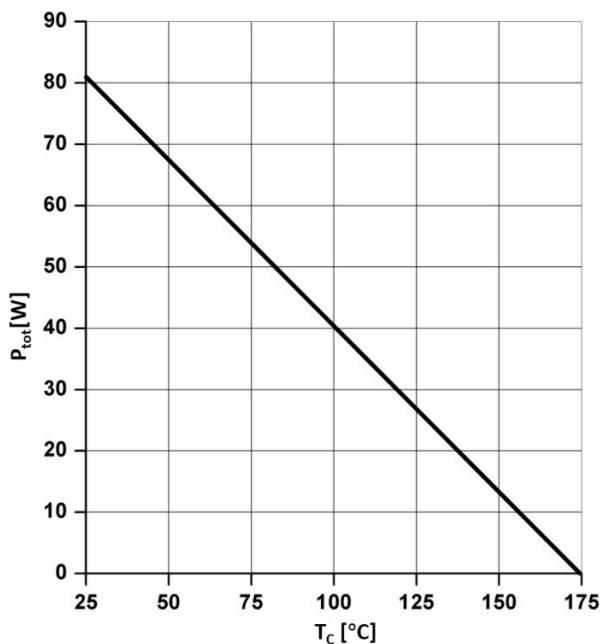


Figure.7 Power dissipation

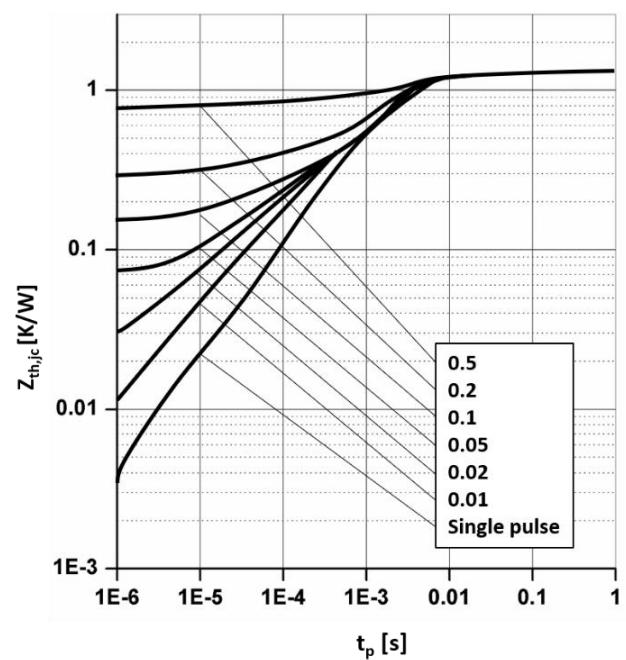


Figure.8 Transient thermal impedance



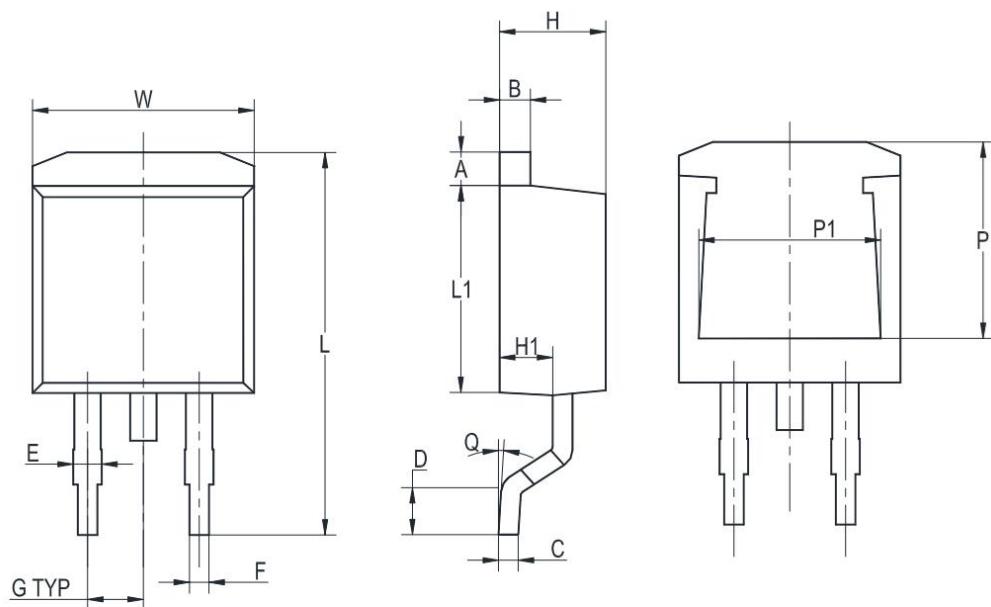
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Package outlines (Units: mm)

TO-263-3



UNIT	A	B	C	D	E	F	G	W	H	H1	L	L1	Q	P	P1
mm	1.5	1.5	0.5	2.60	1.6	0.94	2.54 TYP	10.5	4.8	2.9	16.5	8.7	8° MAX	7.6	8.2
	1.1	1.1	0.3	2.15	1.1	0.68		9.6	4.4	2.5	14.5	8.2		7.1	7.4